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### (54) Curable fluoropolyether rubber compositions

(57) A fluoropolyether rubber composition comprising (A) a linear fluoropolyether compound containing at least two alkenyl groups and having a perfluoroalkyl ether structure in its backbone, (B) an organosilicon compound having at least two silicon atom-bound hydrogen atoms which all form  $\text{H-Si}(\text{C}_a\text{H}_{2a})\text{Si}$  structures

wherein "a" is 1, 2 or 3, (C) a hydrosilylation catalyst, and (D) an antidegradant, typically an aromatic secondary amine compound is curable into products having heat resistance, chemical resistance, solvent resistance, parting property, water repellency, oil repellency, and weather resistance as well as resistance to acid, alkali and oxidative degradation.

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**Description**

[0001] This invention relates to a curable fluoropolyether rubber composition which cures into products having heat resistance, chemical resistance, solvent resistance, parting property, water repellency, oil repellency, and weather resistance as well as resistance to acid, alkali and oxidative degradation.

**BACKGROUND**

[0002] Japanese Patent No. 2,990,646 discloses a composition comprising a linear fluoropolyether compound containing at least two alkenyl groups per molecule and having a perfluoropolyether structure in its backbone, an organo-silicon compound having at least two H-SiO<sub>3</sub>Si structures per molecule, and a hydrosilylation catalyst. This composition cures into products having a good profile of heat resistance, chemical resistance, solvent resistance, parting property, water repellency, oil repellency, and weather resistance.

[0003] Although such fluoropolyether rubber compositions exhibit satisfactory performance in most applications, more acid resistance is required in semiconductor and engine oil-related applications.

[0004] An object of the invention is to provide a curable fluoropolyether rubber composition which cures into products having heat resistance, chemical resistance, solvent resistance, parting property, water repellency, oil repellency, and weather resistance as well as resistance to acid, alkali and oxidative degradation.

[0005] We have found that a fluoropolyether rubber composition obtained by blending (A) a linear fluoropolyether compound containing at least two alkenyl groups and having a perfluoroalkyl ether structure in its backbone, (B) an organosilicon compound having at least two silicon atom-bound hydrogen atoms which all form H-Si(C<sub>a</sub>H<sub>2a</sub>)Si structures, (C) a hydrosilylation catalyst, and (D) an antidegradant is curable into products having heat resistance, chemical resistance, solvent resistance, parting property, water repellency, oil repellency, and weather resistance as well as resistance to acid, alkali and oxidative degradation.

[0006] The invention provides a curable fluoropolyether rubber composition comprising

(A) a linear fluoropolyether compound containing at least two alkenyl groups in a molecule and having a perfluoroalkyl ether structure in its backbone,

(B) an organosilicon compound having at least two hydrogen atoms each bound to a silicon atom in a molecule, all the silicon atom-bound hydrogen atoms constituting a H-Si(C<sub>a</sub>H<sub>2a</sub>)Si structure wherein "a" is an integer of 1 to 3,

(C) a hydrosilylation catalyst, and

(D) an antidegradant.

Other aspects are set out in the claims and may incorporate any of the options set out below.

**FURTHER EXPLANATIONS; OPTIONS AND PREFERENCES**

[0007] The respective components of the curable fluoropolyether rubber composition are described below.

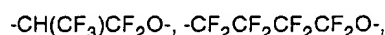
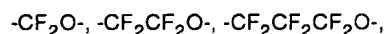
[0008] The linear fluoropolyether compound (A) used herein is one containing at least two alkenyl groups in a molecule and having a divalent perfluoroalkyl ether structure in its backbone.

[0009] The perfluoroalkyl ether structure is a structure containing a plurality of recurring units of the formula: -C<sub>d</sub>F<sub>2d</sub>O- wherein d is independently on each occurrence an integer of 1 to 6. Typical structure has the following general formula (5):



wherein q is an integer of 1 to 500, preferably 2 to 400, more preferably 10 to 200.

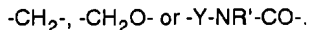
[0010] Examples of the recurring units of formula (5) are shown below.



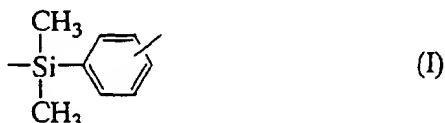


Of these,  $-\text{CF}_2\text{O}-$ ,  $-\text{CF}_2\text{CF}_2\text{O}-$ ,  $-\text{CF}_2\text{CF}_2\text{CF}_2\text{O}-$ , and  $-\text{CH}(\text{CF}_3)\text{CF}_2\text{O}-$  are preferred. It is understood that the perfluoroalkyl ether structure may consist of recurring units of one type or recurring units of two or more types.

[0011] The alkenyl groups in the linear fluoropolyether compound are those of 2 to 8 carbon atoms, especially 2 to 6 carbon atoms, having a  $\text{CH}_2=\text{CH}-$  structure at an end such as vinyl, allyl, propenyl, isopropenyl, butenyl and hexenyl, with vinyl and allyl being especially preferred. The alkenyl groups may be present within the molecule, although they are preferably attached to both ends of the molecular chain. In the preferred case, the alkenyl groups may be attached either directly to both ends of the backbone of the linear fluoropolyether compound or to the backbone (e.g. as side groups) through a divalent linking group such as



Herein Y is  $-\text{CH}_2-$  or a group of the following structural formula (I):



(the bond may be at o, m or p-position) and R' is hydrogen, methyl, phenyl or allyl.

[0012] Preferred linear fluoropolyether compounds (A) are those of the following general formula (1) or (2).

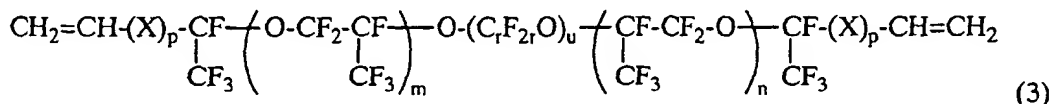


Herein X is independently  $-\text{CH}_2-$ ,  $-\text{CH}_2\text{O}-$  or  $-\text{Y}-\text{NR}'-\text{CO}-$  wherein Y is  $-\text{CH}_2-$  or a group of the following structural formula (I):



(the bond may be at o, m or p-position) and R' is hydrogen, methyl, phenyl or allyl. Q is a divalent hydrocarbon group having 1 to 15 carbon atoms, which may contain ether bond. R' is a divalent perfluoroalkylene or perfluorooxyalkylene group, and p is independently equal to 0 or 1.

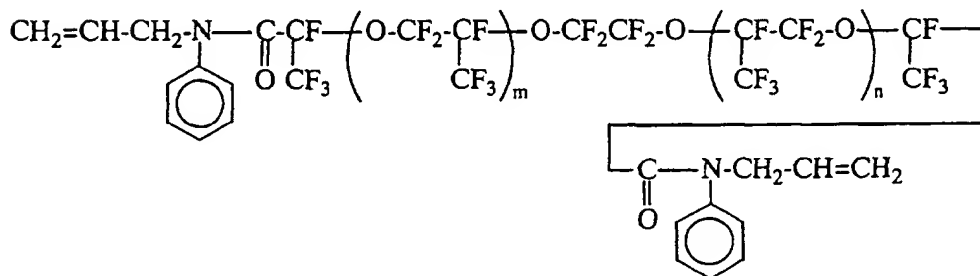
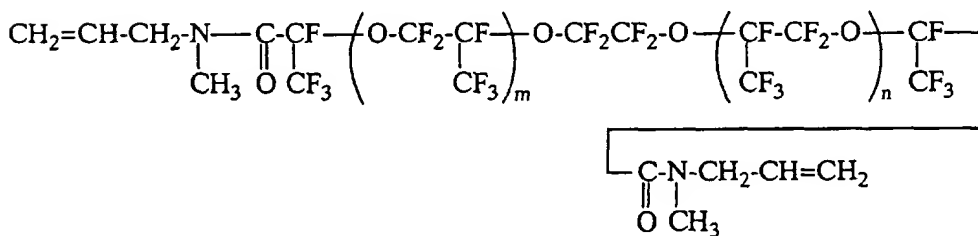
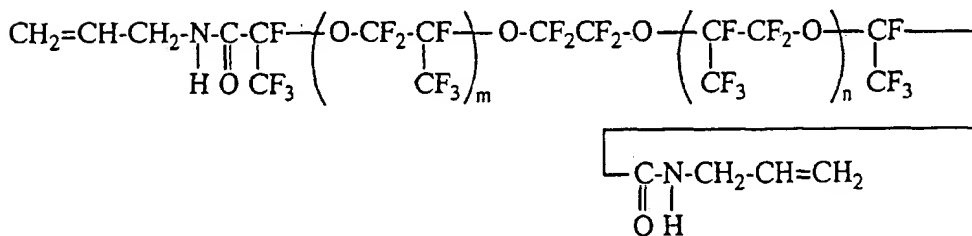
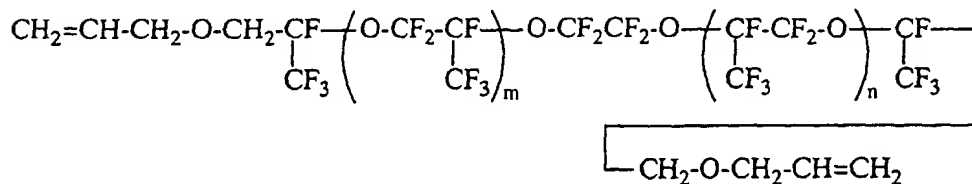
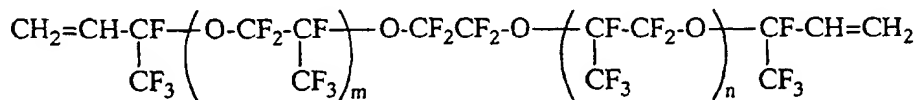
[0013] Of these, fluoropolyether compounds of the following general formula (3) are especially preferred.

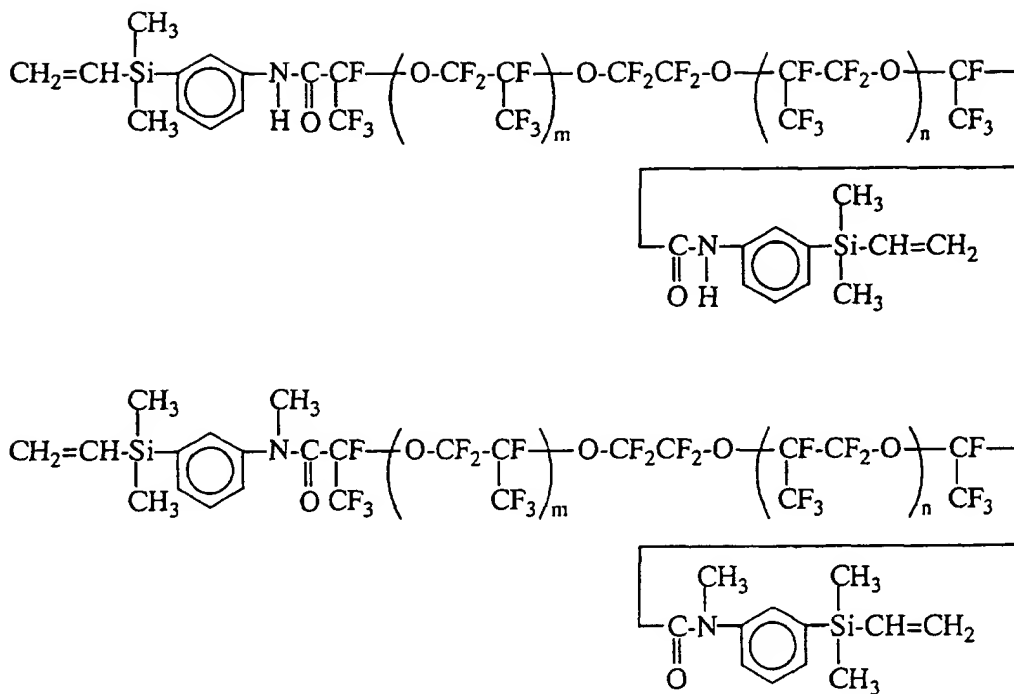


Herein X is as defined above, p is independently equal to 0 or 1, r is an integer of 2 to 6, u is an integer of 1 to 6, and m and n each are an integer of 0 to 200.

[0014] The linear fluoropolyether compound of formula (3) desirably has a weight average molecular weight of about 400 to about 100,000, and especially about 1,000 to about 50,000.

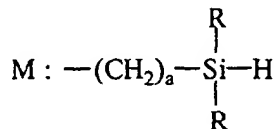
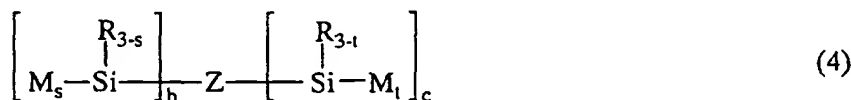
[0015] Illustrative examples of the fluoropolyether compound of formula (3) are given below. In the following formulae, m and n are as defined above.





[0016] It is sometimes preferred to adjust the linear fluoropolyether compound to a desired weight average molecular weight for a particular application. In this case, a linear fluoropolyether compound is subjected to hydrosilylation reaction with an organosilicon compound having two SiH groups in a molecule by a conventional method under ordinary conditions to give a chain-lengthened product, which can be used as component (A).

[0017] The organosilicon compound (B) functions as a crosslinker and chain extender for component (A). Any organosilicon compound is useful as long as it has at least two hydrogen atoms each bound to a silicon atom in a molecule, all the silicon atom-bound hydrogen atoms forming H-Si(C<sub>a</sub>H<sub>2a</sub>)Si structures wherein "a" is an integer of 1 to 3. Typical organosilicon compounds have the following general formula (4).



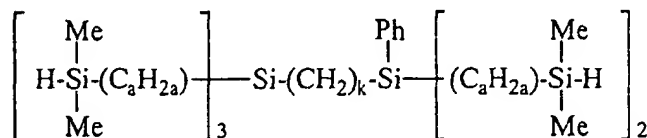
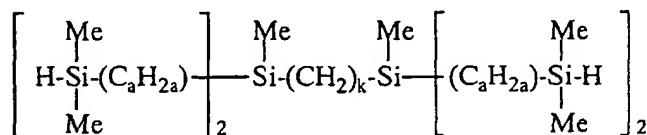
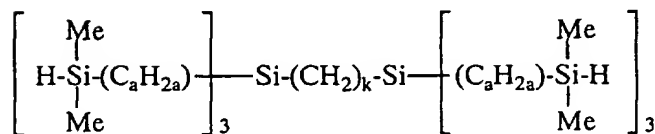
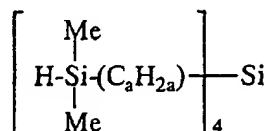
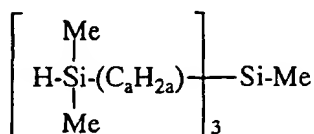
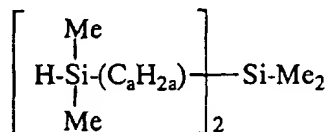
Herein R which may be the same or different is a monovalent hydrocarbon group having 1 to 20 carbon atoms. Z is hydrogen or a mono- or divalent group of the formula: -R, -M, -Q-Rf, -Q-, -Rf- or -Q-Rf-Q- wherein Q is a divalent hydrocarbon group having 1 to 15 carbon atoms, which may include any of ether, amide and carbonyl groups, Rf is a monovalent perfluoroalkyl or perfluorooxyalkyl group, and Rf' is a divalent perfluoroalkylene or perfluorooxyalkylene group. The subscripts "s" and "t" each are 1, 2 or 3, "b" and "c" each are 0 or 1, "b" and "c" are not 0 at the same time, and "a" is 1, 2 or 3.

[0018] Examples of the monovalent hydrocarbon group represented by R include alkyl groups such as methyl, ethyl and propyl and aryl groups such as phenyl, although the detail of R will be described later. Examples of the divalent hydrocarbon group represented by Q include alkylene groups such as methylene, ethylene, propylene, tetramethylene,

and hexamethylene, arylene groups such as phenylene, and combinations of alkylene groups with arylene groups. These groups may include any of ether, amide and carbonyl linkages/groups.

[0019] Z is either a monovalent group (such as -H, -R, -M, or -Q-Rf) or a divalent group (such as -Q-, -Rf'- or -Q-Rf'-Q-), which depends on the values of b and c.

[0020] Illustrative examples of the organosilicon compound of formula (4) are given below. In the following formulae, Me is methyl.



Note that "a" is an integer of 1 to 3 and k is an integer of 1 to 8.

[0021] With the compatibility with and dispersibility in component (A), and uniformity after curing taken into account, organosilicon compounds having at least one monovalent perfluoroalkyl group, monovalent perfluorooxyalkyl group, divalent perfluoroalkylene group or divalent perfluorooxyalkylene group are also useful.

[0022] The preferred perfluoroalkyl and perfluoroalkylene groups are those of 1 to about 20 carbon atoms, and the preferred perfluorooxyalkyl and perfluorooxyalkylene groups are those of 1 to about 500 carbon atoms, especially 4 to about 500 carbon atoms.

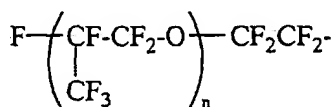
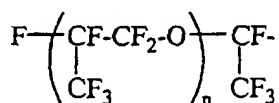
[0023] The perfluoroalkyl, perfluorooxyalkyl, perfluoroalkylene and perfluorooxyalkylene groups are exemplified by the groups of the following general formulae. monovalent perfluoroalkyl groups:



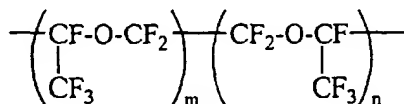
g is an integer of 1 to 20, preferably 2 to 10. divalent perfluoroalkylene groups:



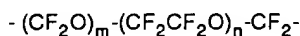
g is an integer of 1 to 20, preferably 2 to 10. monovalent perfluorooxyalkyl groups:



n is an integer of 1 to 5.  
divalent perfluorooxyalkylene groups:

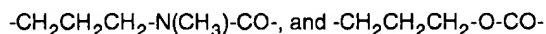
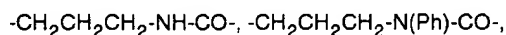
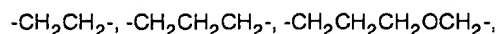


m+n is an integer of 2 to 100.



m and n each are an integer of 1 to 50.

[0024] These perfluoro(oxy)alkyl and perfluoro(oxy)alkylene groups each may be attached either directly to a silicon atom or to a silicon atom through a divalent linking group. The divalent linking group is an alkylene group, arylene group or a mixture thereof, which may also include any of ether bond oxygen atom, amide bond or carbonyl bond. Such divalent linking groups of 2 to 12 carbon atoms are preferred. Illustrative examples thereof include

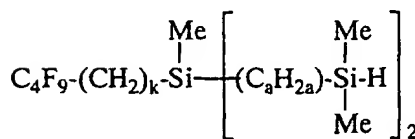
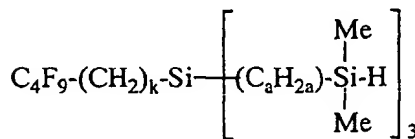
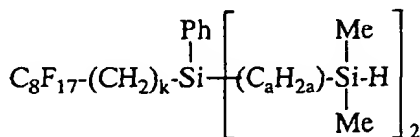
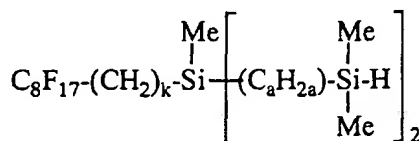
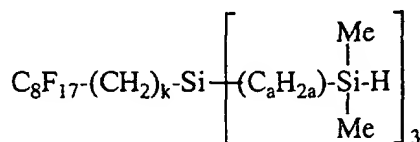


wherein Ph is phenyl.

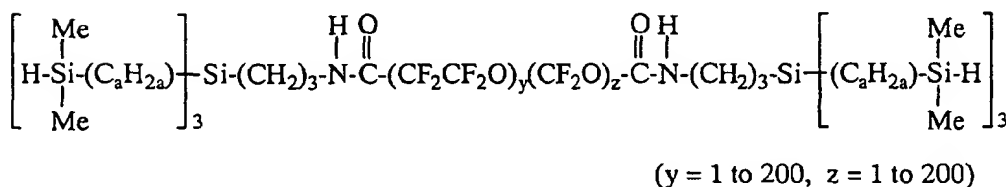
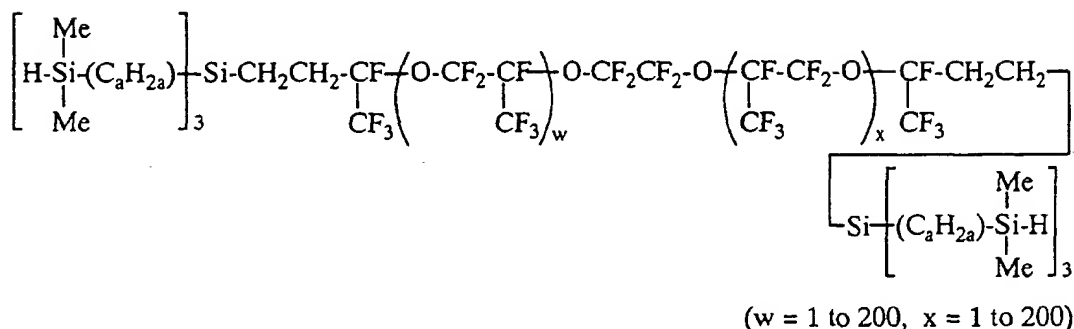
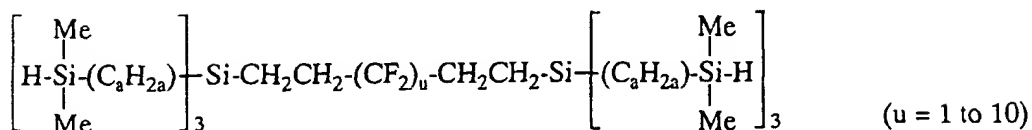
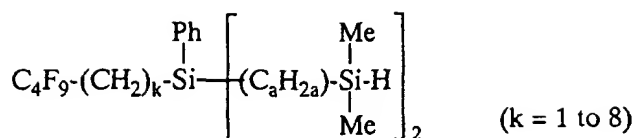
[0025] In addition to the monovalent organic group containing a monovalent or divalent fluorinated substituent, that is, a perfluoroalkyl, perfluoroalkoxyalkyl, perfluoroalkylene or perfluoroalkoxyalkylene group, the organosilicon compound (B) may have a monovalent substituent attached to a silicon atom. Exemplary monovalent substituents are substituted or unsubstituted hydrocarbon groups of 1 to 20 carbon atoms including alkyl groups such as methyl, ethyl, propyl, butyl, hexyl, cyclohexyl, octyl and decyl; alkenyl groups such as vinyl and allyl; aryl groups such as phenyl, tolyl, and naphthyl; aralkyl groups such as benzyl and phenylethyl; and substituted ones of these groups in which some of the hydrogen atoms are replaced by chlorine atoms, cyano groups or the like, such as chloromethyl, chloropropyl, and cyanoethyl. These choices are also valid for R in formula (4).

[0026] The organosilicon compound (B) may be cyclic, chainlike or three-dimensional network. The number of silicon atoms per molecule of the organosilicon compound is not critical although it desirably has about 2 to about 60 silicon atoms, and especially about 3 to about 30 silicon atoms. Typically it has no silicone/siloxane moieties and/or no organohydrogensiloxane moieties; in the latter case all of the Si-bonded H atoms can be disposed as prescribed above.

[0027] Illustrative examples of the organosilicon compound are given below. They may be used alone or in admixture of two or more. In the formulae, Me is methyl and Ph is phenyl.







[0028] The organosilicon compound having hydrosilyl groups (B) is preferably blended in such an amount that 0.5 to 5 mol, and more preferably 1 to 2 mol of hydrosilyl groups (or SiH) groups may be present per mol of alkenyl groups (e.g., vinyl, allyl or cycloalkenyl) in component (A). Less amounts of component (B) may achieve an insufficient degree of crosslinking. Excessive amounts of component (B) may allow chain lengthening to become preferential, inviting short cure, foaming, and losses of heat resistance and compression set. The organosilicon compounds may be used alone or in admixture of two or more.

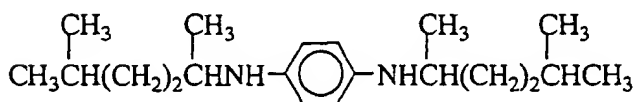
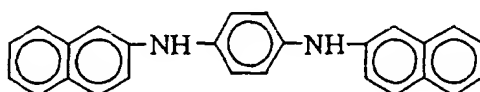
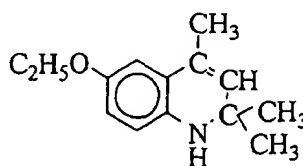
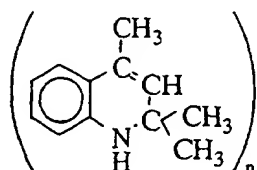
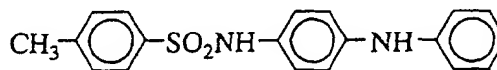
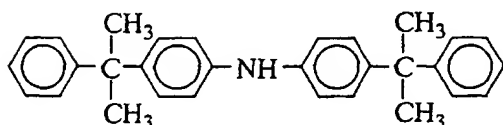
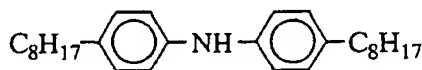
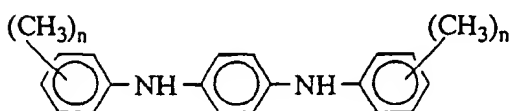
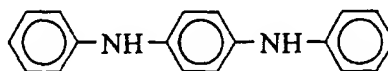
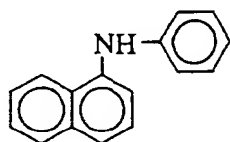
[0029] The hydrosilylation catalyst (C) is preferably selected from transition metals, for example, platinum group metals such as Pt, Rh and Pd, and compounds of transition metals. Most of these compounds are noble metal compounds which are expensive. Platinum compounds tend to be used because they are readily available. Exemplary platinum compounds include chloroplatinic acid, complexes of chloroplatinic acid with olefins such as ethylene, complexes of chloroplatinic acid with alcohols and vinylsiloxanes, and platinum supported on silica, alumina or carbon though not limited thereto. Known platinum group metal compounds other than the platinum compounds include rhodium, ruthenium, iridium, and palladium compounds, for example,  $\text{RhCl}(\text{PPh}_3)_3$ ,  $\text{RhCl}(\text{CO})(\text{PPh}_3)_2$ ,  $\text{RhCl}(\text{C}_2\text{H}_4)_2$ ,  $\text{Ru}_3(\text{CO})_{12}$ ,  $\text{IrCl}(\text{CO})(\text{PPh}_3)_2$ , and  $\text{Pd}(\text{PPh}_3)_4$  wherein Ph denotes phenyl.

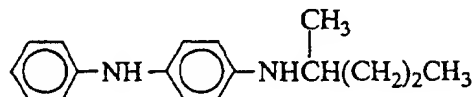
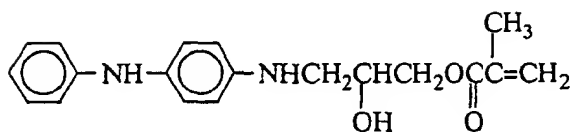
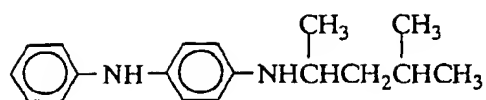
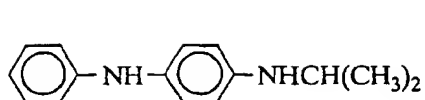
[0030] The amount of the catalyst used is not critical. A catalytic amount can achieve a desired curing rate. From the economical aspect and to obtain satisfactory cured products, the platinum group metal compound is preferably

added in an amount of about 0.1 to about 1,000 parts, more preferably about 0.1 to about 500 parts by weight calculated as the platinum group metal per million parts by weight of the entire curable composition.

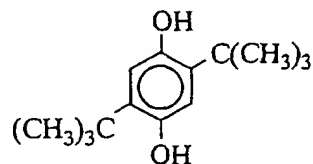
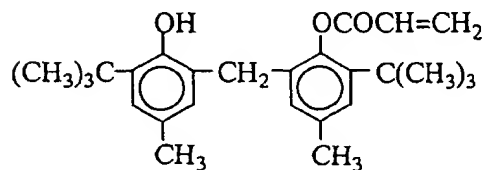
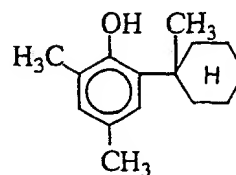
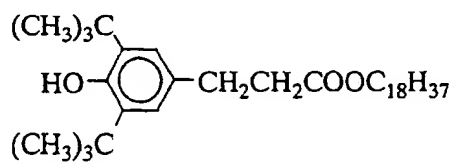
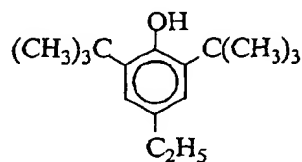
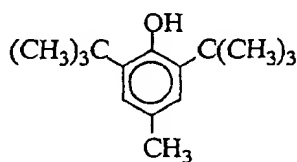
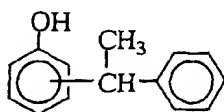
[0031] The antidegradant (D), which is an agent for inhibiting oxidative degradation, is selected from amine compounds, phenolic compounds, sulfur compounds, phosphorus compounds, waxes, and metal complexes thereof. The majority of these compounds are commercially available. Many commercially available antidegradants are suitable.

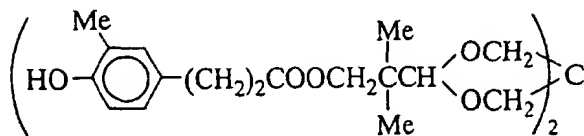
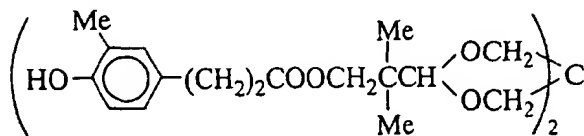
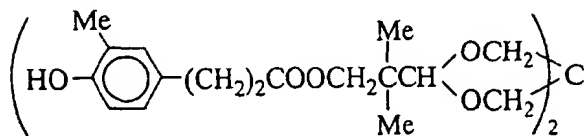
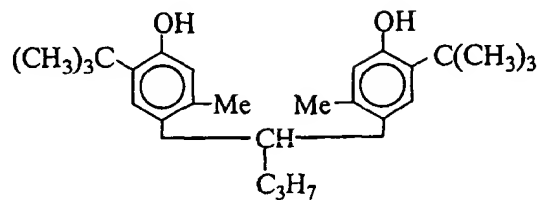
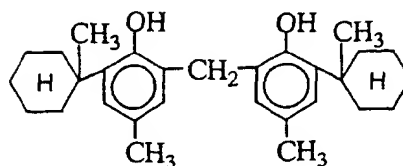
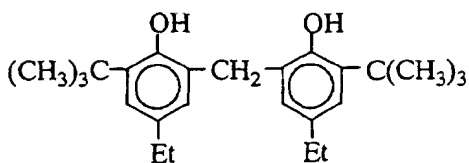
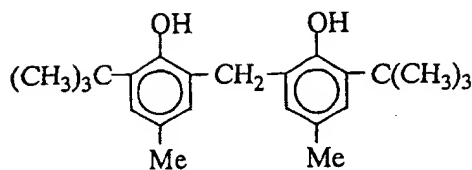
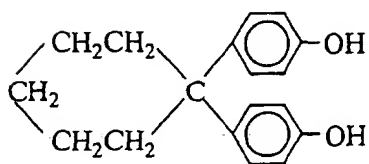
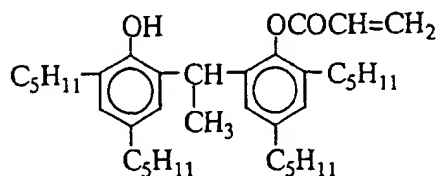
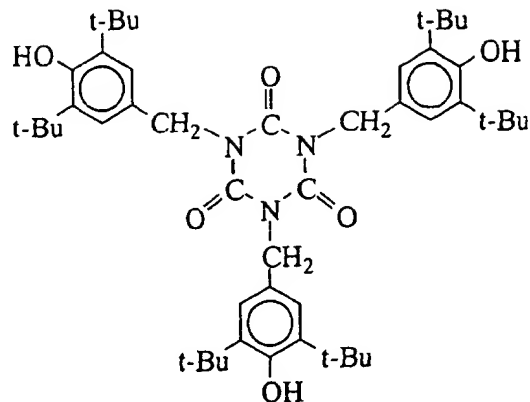
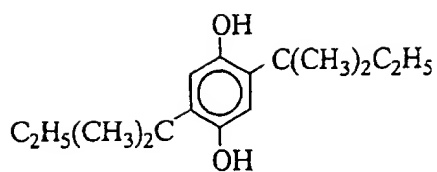
[0032] Examples of suitable amine antidegradants are shown below.

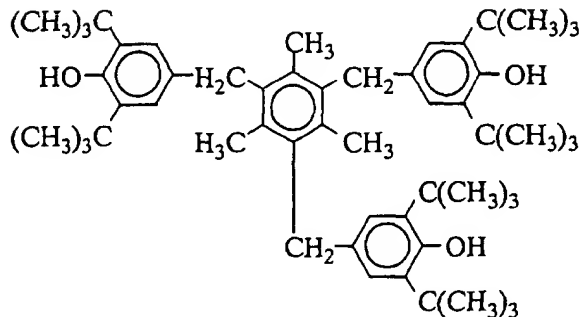
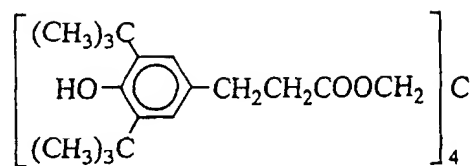




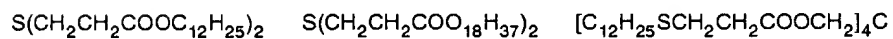
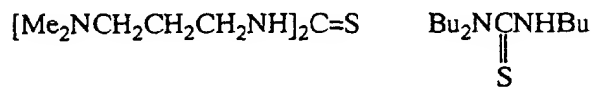
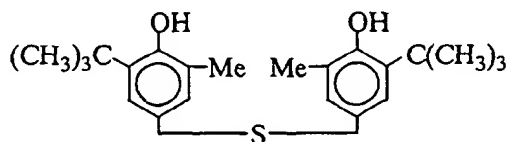
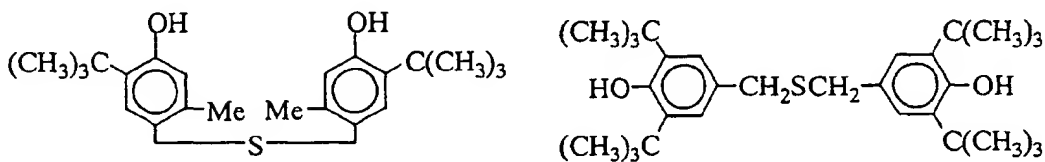
15 [0033] Examples of suitable phenolic antidegradants are shown below.







[0034] Examples of suitable sulfur, phosphorus, metal complex and combined antidegradants are shown below.





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are ionic compounds of heavy metals (see USP 3,532,649).

[0038] In the curable composition of the invention, fillers may be included for the purposes of reducing thermal shrinkage upon curing, reducing the coefficient of thermal expansion of the cured elastomer, improving thermal stability, weather resistance, chemical resistance, flame retardance or mechanical strength, and/or lowering the gas permeability. Exemplary additives include fumed silica, quartz flour, glass fibers, carbon, metal oxides such as iron oxide, titanium oxide and cerium oxide, and metal carbonates such as calcium carbonate and magnesium carbonate. If desired, suitable pigments and dyes are added.

[0039] The method of preparing the curable composition according to the invention is not critical. The composition may be prepared simply by mixing the above-described components. The composition may be formulated as two parts, e.g. one consisting of components (A), (B) and (D) and the other part consisting of components (A) and (C), which are to be combined together on use. For the composition to cure, room temperature cure is possible depending on the type of functional group in component (A) and the type of catalyst (C) although a common, preferred practice is to heat the composition e.g. at from 100 to 200°C for several minutes to several hours for curing.

[0040] On use, depending on its particular application and purpose, the curable composition may be dissolved in a suitable fluorochemical solvent, for example, 1,3-bis(trifluoromethyl)benzene or perfluorooctane in a desired concentration before it is applied.

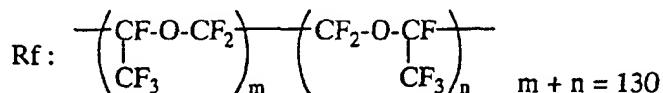
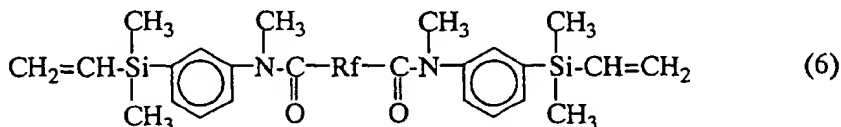
[0041] The curable fluoropolyether rubber composition cures into parts which have good heat resistance, chemical resistance, solvent resistance, parting property, water repellency, oil repellency and weather resistance as well as good resistance to acid, alkali and oxidative degradation. The composition is thus useful in a variety of molding applications, for example, as sealants for semiconductor manufacturing apparatus, O-rings, diaphragms and sealants for automobiles and aircraft, roll materials for copiers, and electrode constituent materials for secondary cells and fuel cells.

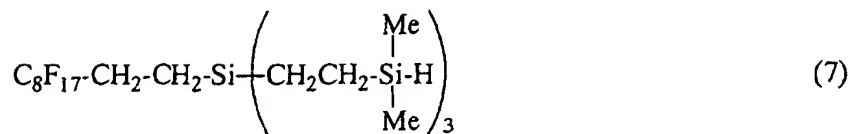
#### EXAMPLE

[0042] Examples of the invention are given below by way of illustration and not by way of limitation. The viscosity is a measurement at 25°C. All parts are by weight.

#### Comparative Example 1

[0043] To 100 parts of a polymer of formula (6) below (viscosity 8,500 cs, average molecular weight 22,000, and vinyl content 0.009 mol/100 g) was added 20 parts of dimethylsiloxyl-treated fumed silica having a specific surface area of 200 m<sup>2</sup>/g. They were mixed, heat treated and milled on a three-roll mill. To the mixture were added 2.64 parts of a fluorinated organosilicon compound of formula (7) below, 0.2 part of a toluene solution of a catalyst in the form of chloroplatinic acid modified with CH<sub>2</sub>=CHSiMe<sub>2</sub>OSiMe<sub>2</sub>CH=CH<sub>2</sub> (platinum concentration 1.0 wt%), and 0.4 part of a 50% toluene solution of ethynyl cyclohexanol. They were mixed to give composition I.





[0044] The composition was deaerated in vacuum, placed in a rectangular frame of 2 mm deep, deaerated again, and press cured at 100 kg/cm<sup>2</sup> and 150°C for 10 minutes. From the cured sample, a specimen was cut out and measured for physical properties according to JIS K-6251 and 6253. The specimen was also examined for chemical resistance and heat resistance in air. The results are shown in Tables 1 and 2.

#### Comparative Example 2

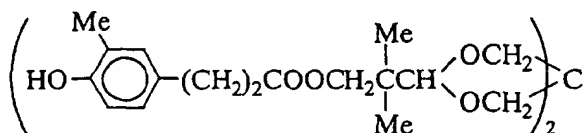
[0045] Composition II was prepared as in Comparative Example 1 except that 2.49 parts of a fluorinated hydrogen-siloxane of formula (8) shown below was used instead of the fluorinated organosilicon compound of formula (7).



[0046] As in Comparative Example 1, a cured sheet was obtained from composition II. A specimen was cut therefrom and measured for physical properties according to JIS K-6251 and 6253. The specimen was also examined for chemical resistance and heat resistance in air. The results are shown in Tables 1 and 2.

#### Example 1

[0047] Composition III was prepared as in Comparative Example 1 except that 1.0 part of an antidegradant as shown below was added prior to the milling on the three-roll mill.

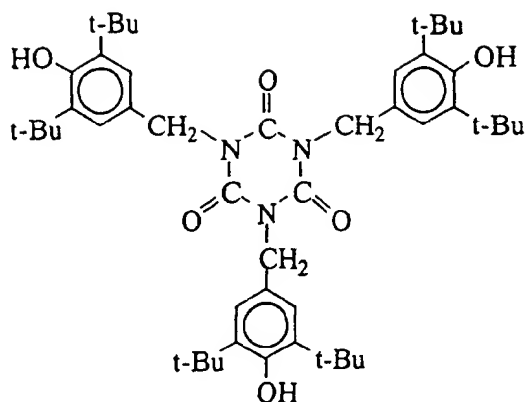


[0048] As in Comparative Example 1, a cured sheet was obtained from composition III. A specimen was cut therefrom and measured for physical properties according to JIS K-6251 and 6253. The specimen was also examined for chemical resistance and heat resistance in air. The results are shown in Tables 1 and 2.

#### Example 2

[0049] Composition IV was prepared as in Comparative Example 1 except that 1.0 part of an antidegradant as shown below was added prior to the milling on the three-roll mill.

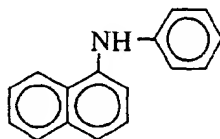




[0050] As in Comparative Example 1, a cured sheet was obtained from composition IV. A specimen was cut therefrom and measured for physical properties according to JIS K-6251 and 6253. The specimen was also examined for chemical resistance and heat resistance in air. The results are shown in Tables 1 and 2.

#### Example 3

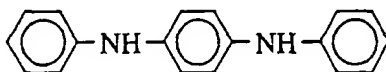
[0051] Composition V was prepared as in Comparative Example 1 except that 1.0 part of an antidegradant shown below was added prior to the milling on the three-roll mill.



[0052] As in Comparative Example 1, a cured sheet was obtained from composition V. A specimen was cut therefrom and measured for physical properties according to JIS K-6251 and 6253. The specimen was also examined for chemical resistance and heat resistance in air. The results are shown in Tables 1 and 2.

#### Example 4

[0053] Composition VI was prepared as in Comparative Example 1 except that 1.0 part of an antidegradant shown below was added prior to the milling on the three-roll mill.



[0054] As in Comparative Example 1, a cured sheet was obtained from composition VI. A specimen was cut therefrom and measured for physical properties according to JIS K-6251 and 6253. The specimen was also examined for chemical resistance and heat resistance in air. The results are shown in Tables 1 and 2.

Table 1:

Chemical resistance (change of rubber hardness)						
	Comparative Example		Example			
Chemicals	1	2	1	2	3	4
Initial	40	41	40	40	41	41
Conc. hydrochloric acid	42(+2)	48(+7)	42(+2)	42(+2)	44(+3)	44(+3)
Conc. sulfuric acid	39(-1)	40(-1)	40(0)	40(0)	41(0)	42(+1)
Conc. hydrofluoric acid	39(-1)	30(-11)	39(-1)	38(-2)	41(0)	41(0)
Trifluoroacetic acid	38(-2)	decomposed	38(-2)	38(-2)	40(-1)	41(0)
40% KOH solution	41(+1)	41(+1)	41(+1)	41(+1)	42(+1)	41(0)

[0055] Degrading conditions are immersion in the designated chemical at 20°C for 3 days. Figures in parentheses denote point increments or decrements from the initial.

[0056] Comparative Example 2 was less resistant to chemicals because the crosslinking agent had a siloxane structure. All other examples were fully resistant to chemicals.

Table 2:

Heat resistance in air							
		Comparative Example		Example			
		1	2	1	2	3	4
Hardness	Initial	40	41	40	40	41	41
	200°C / 7 days	38(-2)	40(-1)	39(-1)	39(-1)	43(+2)	43(+2)
Elongation (%)	Initial	540	620	490	490	530	520
	200°C / 7 days	450(-17)	580(-6)	440(-10)	430(-12)	500(-6)	480(-8)
Tensile strength (MPa)	Initial	10.7	11.8	9.7	9.8	10.5	10.4
	200°C / 7 days	6.7(-37)	11.0(-7)	8.2(-15)	8.0(-18)	9.8(-7)	9.4(-10)

[0057] Figures in parentheses denote point increments or decrements from the initial for the hardness, and percent increments or decrements from the initial for the elongation and tensile strength.

[0058] Examples 1 to 4 corresponded to Comparative Example 1 to which the antidegradants were added. As seen from Table 2, Comparative Example 1 experienced substantial losses of rubber physical properties, especially tensile strength, whereas those compositions having antidegradants added experienced only some losses of rubber physical properties. In particular, Examples 3 and 4 in which aromatic secondary amine compounds were used as the antidegradant experienced a less reduction of rubber physical properties. Comparative Example 2 in which the crosslinking agent had a siloxane structure was more resistant to oxidative degradation than Comparative Example 1.

[0059] It is evident from Tables 1 and 2 that the compositions within the scope of the invention were improved in both chemical resistance and oxidative degradation resistance.

[0060] Japanese Patent Application No. 2000-208633 is incorporated herein by reference.

[0061] Although some preferred embodiments have been described, many modifications and variations may be made thereto in light of the above teachings. It is therefore to be understood that the invention may be practiced otherwise than as specifically described in the Examples.

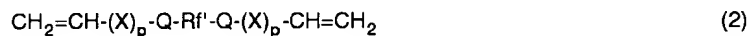
## Claims

1. A curable fluoropolyether rubber composition comprising

(A) linear fluoropolyether compound containing at least two alkenyl groups per molecule and having a per-fluoroalkyl ether structure in its backbone,

(B) organosilicon compound having per molecule at least two Si-bound hydrogen atoms each in a  $\text{H-Si}(\text{C}_a\text{H}_{2a})$  Si structure,  
 where a is an integer from 1 to 3;  
 (C) hydrosilylation catalyst, and  
 (D) antidegradant.

2. The composition of claim 1 wherein the linear fluoropolyether compound (A) has the following general formula (1) or (2):

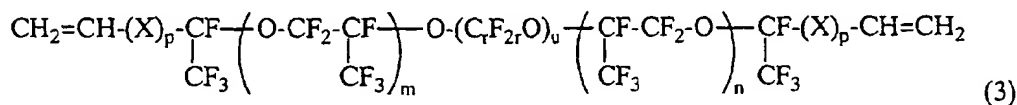


wherein X are independently  $-\text{CH}_2-$ ,  $-\text{CH}_2\text{O}-$  or  $-\text{Y}-\text{NR}'-\text{CO}-$  where Y is  $-\text{CH}_2-$  or a group of the following structural formula (I):

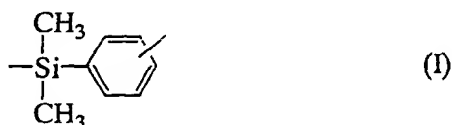


and R' is hydrogen, methyl, phenyl or allyl,  
 Q is a divalent hydrocarbon group having 1 to 15 carbon atoms, which may contain ether bond,  
 Rf' is a divalent perfluoroalkylene or perfluorooxyalkylene group, and  
 indices p are independently 0 or 1.

3. The composition of claim 1 wherein the linear fluoropolyether compound (A) has the following general formula (3):

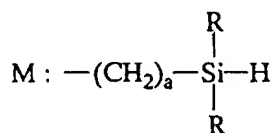
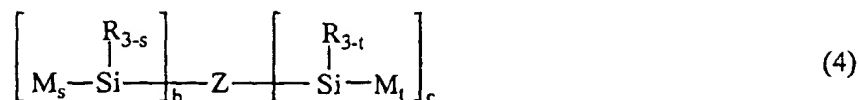


wherein X are independently  $-\text{CH}_2-$ ,  $-\text{CH}_2\text{O}-$  or  $-\text{Y}-\text{NR}'-\text{CO}-$  where Y is  $-\text{CH}_2-$  or a group of the following structural formula:



and R' is hydrogen, methyl, phenyl or allyl,  
 indices p are independently 0 or 1, r is an integer from 2 to 6, u is an integer from 1 to 6, and m and n are integers from 0 to 200.

4. Composition of claim 1, 2 or 3 wherein the organosilicon compound (B) has the following general formula (4):



wherein R which may be the same or different is a monovalent hydrocarbon group having 1 to 20 carbon atoms, Z is hydrogen or a mono- or divalent group of the formula: -R, -M, -Q-Rf, -Q-, -Rf- or -Q-Rf-Q- wherein Q is a divalent hydrocarbon group having 1 to 15 carbon atoms, which may contain ether bond, amide bond or carbonyl bond, Rf is a monovalent perfluoroalkyl or perfluorooxyalkyl group, and Rf' is a divalent perfluoroalkylene or perfluorooxyalkylene group, s and t each are 1, 2 or 3, b and c each are 0 or 1, b and c are not 0 at the same time, and "a" is 1, 2 or 3.

5. A composition according to any one of the preceding claims wherein the antidegradant (D) is an amine or phenolic compound.
6. The composition of claim 5 wherein the antidegradant (D) is an aromatic secondary amine compound.
7. A process comprising the preparation of a composition according to any one of claims 1 to 6 by blending the ingredients thereof (but which may be a two-part composition).
8. A method of making an article comprising moulding and curing a composition according to any one of claims 1 to 6.
9. A moulded article made of a cured composition according to any one of claims 1 to 6.
10. A moulded article according to claim 9 which is a seal, diaphragm, roller or electrode component.



European Patent  
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## EUROPEAN SEARCH REPORT

Application Number  
EP 01 30 5892

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.7)
A	US 5 837 774 A (FUKUDA KENICHI ET AL) 17 November 1998 (1998-11-17) * column 1, line 39 - column 9, line 59; claims; examples * ----	1-10	C08L83/08 C08L83/10 C08L71/00
A,D	EP 0 725 113 A (SHINETSU CHEMICAL CO) 7 August 1996 (1996-08-07) * page 2, line 25 - page 14, line 42; claim 2; examples * -----	1-10	
			TECHNICAL FIELDS SEARCHED (Int.Cl.7)
			C08L
The present search report has been drawn up for all claims			
Place of search <b>MUNICH</b>		Date of completion of the search <b>16 October 2001</b>	Examiner <b>Kolitz, R</b>
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document			

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**ANNEX TO THE EUROPEAN SEARCH REPORT  
ON EUROPEAN PATENT APPLICATION NO.**

EP 01 30 5892

This annex lists the patent family members relating to the patent documents cited in the above-mentioned European search report.  
The members are as contained in the European Patent Office EDP file on  
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16-10-2001

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		JP 8269317 A	15-10-1996
EP 0725113 A	07-08-1996	JP 2990646 B2	13-12-1999
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